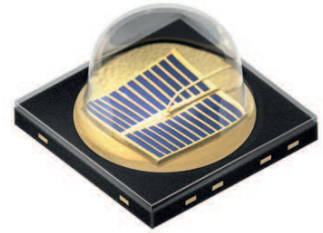


# OSLON Black Series (940 nm) - 90°

## Version 1.6

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### SFH 4725S



#### Features:

- IR lightsource with high efficiency
- Double Stack emitter
- Low thermal resistance (Max. 11 K/W)
- Centroid wavelength 940 nm
- Superior Corrosion Robustness (see chapter package outlines)
- The product qualification test plan is based on the guidelines of AEC-Q101-REV-C, Stress Test Qualification for Automotive Grade Discrete Semiconductors.

#### Applications

- Infrared Illumination for cameras
- Machine vision systems
- Surveillance systems
- Eye tracking systems

#### Notes

Depending on the mode of operation, these devices emit highly concentrated non visible infrared light which can be hazardous to the human eye. Products which incorporate these devices have to follow the safety precautions given in IEC 60825-1 and IEC 62471.

#### Ordering Information

Type:	Radiant Intensity $I_e$ [mW/sr] $I_F = 1 \text{ A}, t_p = 10 \text{ ms}$	Ordering Code
SFH 4725S	425 ( $\geq 320$ )	Q65111A2800

Note: measured at a solid angle of  $\Omega = 0.01 \text{ sr}$

**Maximum Ratings** ( $T_A = 25\text{ °C}$ )

Parameter	Symbol	Values	Unit
Operating temperature range	$T_{op}$	-40 ... 125	°C
Storage temperature range	$T_{stg}$	-40 ... 125	°C
Junction temperature	$T_j$	145	°C
Reverse voltage	$V_R$	1	V
Forward current	$I_F$	1000	mA
Surge current ( $t_p = 500\ \mu\text{s}$ , $D = 0$ )	$I_{FSM}$	5	A
Power consumption	$P_{tot}$	3.4	W
Thermal resistance junction - solder point	$R_{thJS}$	11	K / W
ESD withstand voltage (acc. to ANSI/ ESDA/ JEDEC JS-001 - HBM)	$V_{ESD}$	2	kV

*Note:* For the forward current and power consumption please see "maximum permissible forward current" diagram

**Characteristics** ( $T_A = 25\text{ °C}$ )

Parameter	Symbol	Values	Unit
Peak wavelength ( $I_F = 1\text{ A}$ , $t_p = 10\text{ ms}$ )	$\lambda_{peak}$	950	nm
Centroid wavelength ( $I_F = 1\text{ A}$ , $t_p = 10\text{ ms}$ )	$\lambda_{centroid}$	940	nm
Spectral bandwidth at 50% of $I_{max}$ ( $I_F = 1\text{ A}$ , $t_p = 10\text{ ms}$ )	$\Delta\lambda$	37	nm
Half angle	$\varphi$	$\pm 45$	°
Dimensions of active chip area	L x W	1 x 1	mm x mm
Rise and fall times of $I_e$ ( 10% and 90% of $I_{e,max}$ ) ( $I_F = 5\text{ A}$ , $R_L = 50\ \Omega$ )	$t_r / t_f$	10/15	ns
Forward voltage ( $I_F = 1\text{ A}$ , $t_p = 100\ \mu\text{s}$ )	$V_F$	2.75 ( $\leq 3.4$ )	V
Forward voltage ( $I_F = 5\text{ A}$ , $t_p = 100\ \mu\text{s}$ )	$V_F$	3.4 ( $\leq 4.5$ )	V
Reverse current ( $V_R = 5\text{ V}$ )	$I_R$	not designed for reverse operation	$\mu\text{A}$
Total radiant flux ( $I_F = 1\text{ A}$ , $t_p = 100\ \mu\text{s}$ )	$\Phi_e$	990	mW

Parameter		Symbol	Values	Unit
Temperature coefficient of $I_e$ or $\Phi_e$ ( $I_F = 1$ A, $t_p = 10$ ms)	(typ)	$TC_I$	-0.3	% / K
Temperature coefficient of $V_F$ ( $I_F = 1$ A, $t_p = 10$ ms)	(typ)	$TC_V$	-2	mV / K
Temperature coefficient of wavelength ( $I_F = 1$ A, $t_p = 10$ ms)	(typ)	$TC_\lambda$	0.3	nm / K

### Grouping ( $T_A = 25$ °C)

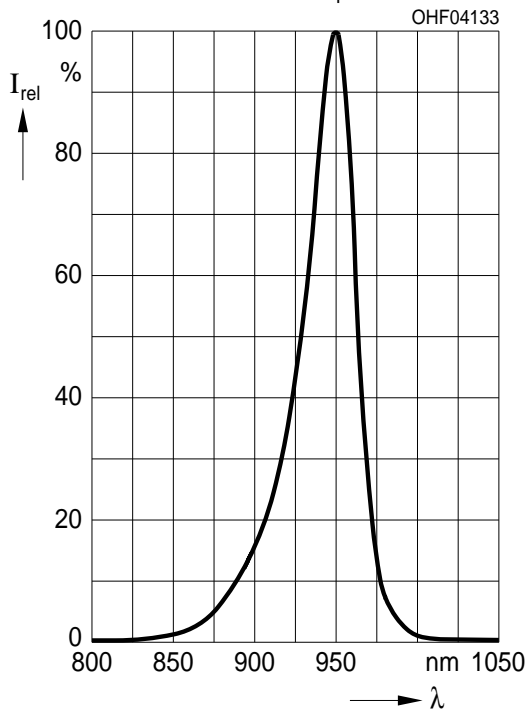
Group	Min Radiant Intensity	Max Radiant Intensity
	$I_F = 1$ A, $t_p = 10$ ms $I_{e, \min}$ [mW / sr]	$I_F = 1$ A, $t_p = 10$ ms $I_{e, \max}$ [mW / sr]
SFH 4725S -CB	320	500
SFH 4725S -DA	400	630
SFH 4725S -DB	500	800

Note: measured at a solid angle of  $\Omega = 0.01$  sr

Only one group in one packing unit (variation lower 1.6:1).

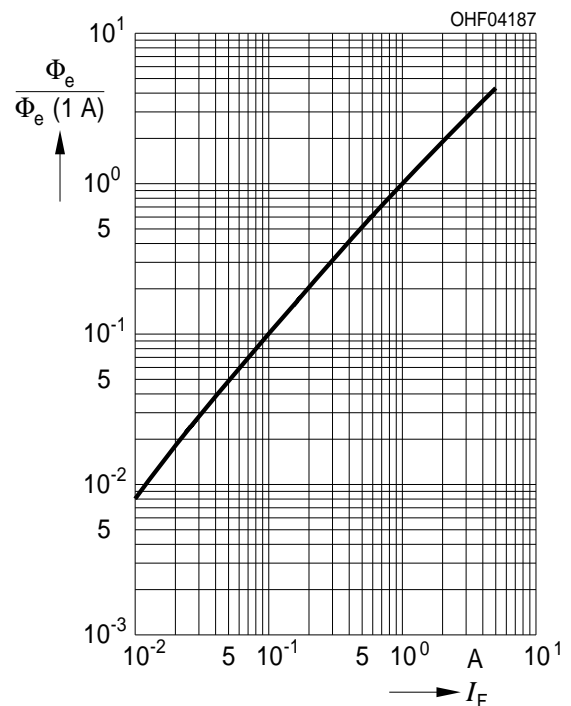
### Relative Spectral Emission <sup>1) page 12</sup>

$I_{rel} = f(\lambda)$ ,  $T_A = 25$  °C,  $I_F = 1$ A,  $t_p = 10$  ms



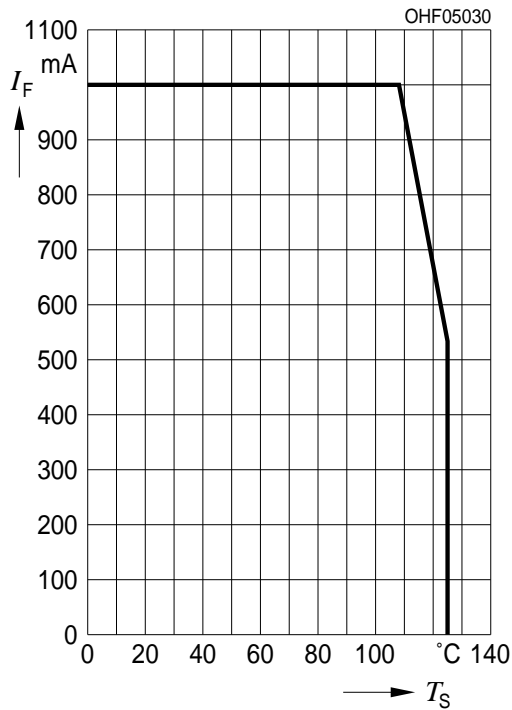
### Relative Total Radiant Flux <sup>1) page 12</sup>

$\Phi_e / \Phi_e(1A) = f(I_F)$ ,  $T_A = 25$  °C, Single pulse,  $t_p = 100$   $\mu$ s



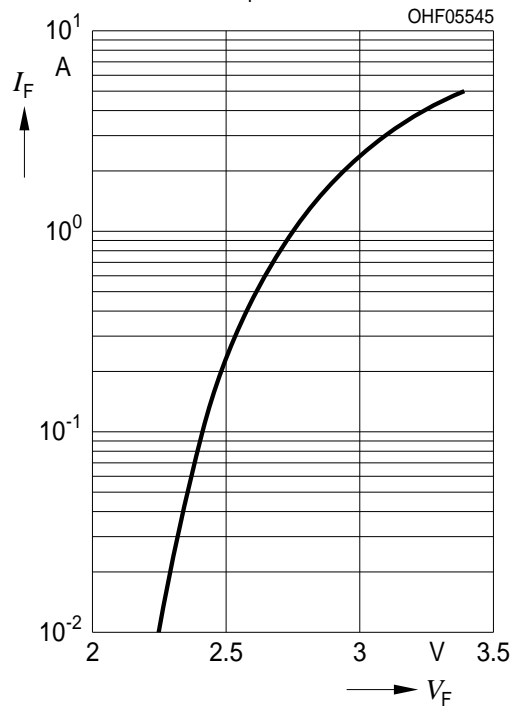
**Max. Permissible Forward Current**

$I_F = f(T_S), R_{thJS} = 11 \text{ K/W}$



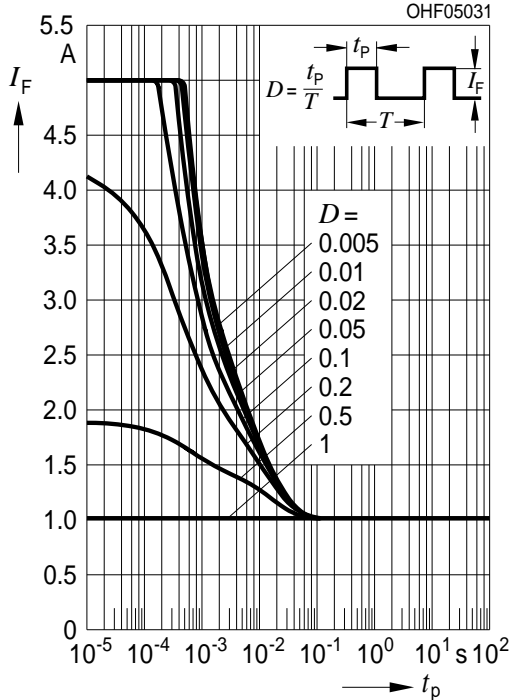
**Forward Current** <sup>1) page 12</sup>

$I_F = f(V_F), \text{ single pulse, } t_p = 100 \mu\text{s}, T_A = 25^\circ\text{C}$



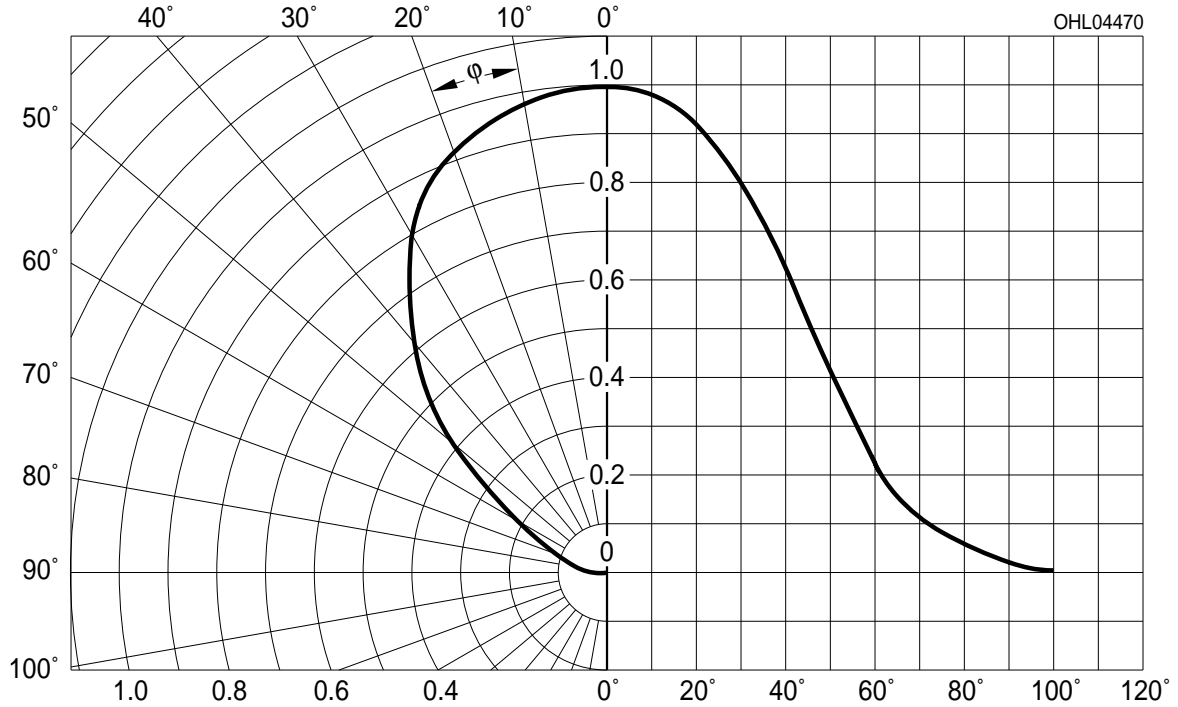
**Permissible Pulse Handling Capability**

$I_F = f(t_p), T_S = 85^\circ\text{C}, \text{ Duty cycle } D = \text{parameter}$

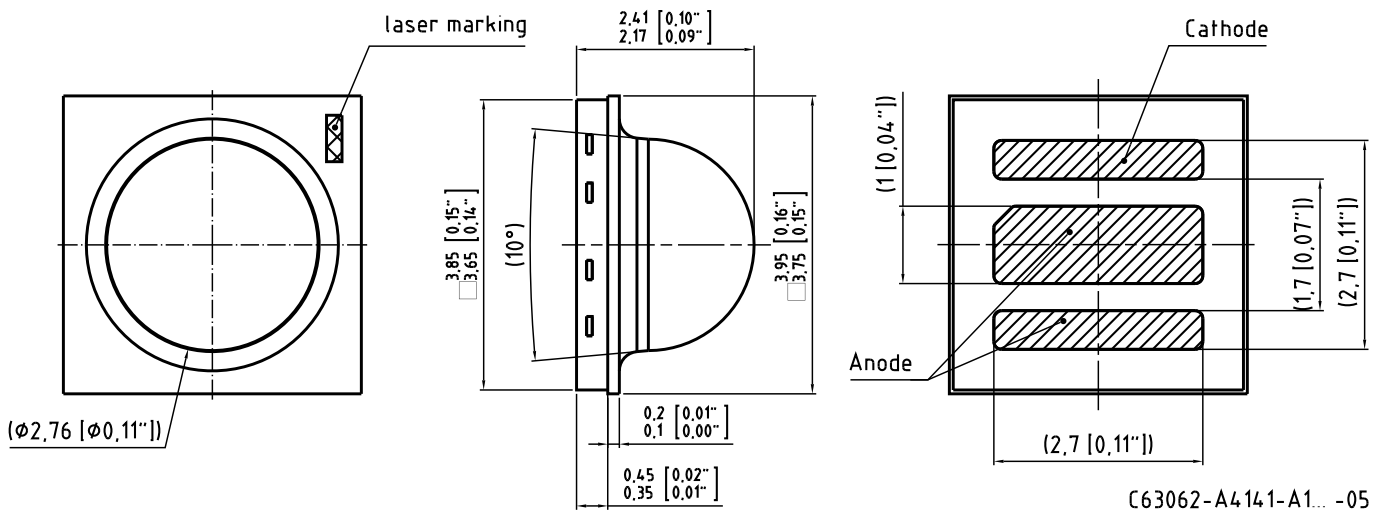


**Radiation Characteristics** <sup>1) page 12</sup>

$I_{rel} = f(\phi), T_A = 25^\circ C$



**Package Outline**



*Dimensions in mm [inch].*

**Package**

OSLON Black Series

**Approximate Weight:**

31 mg

**Package marking**

Anode mark: Anode pad has chamfered edge, which points to cathode Approx. weight: 32 mg

**Note:**

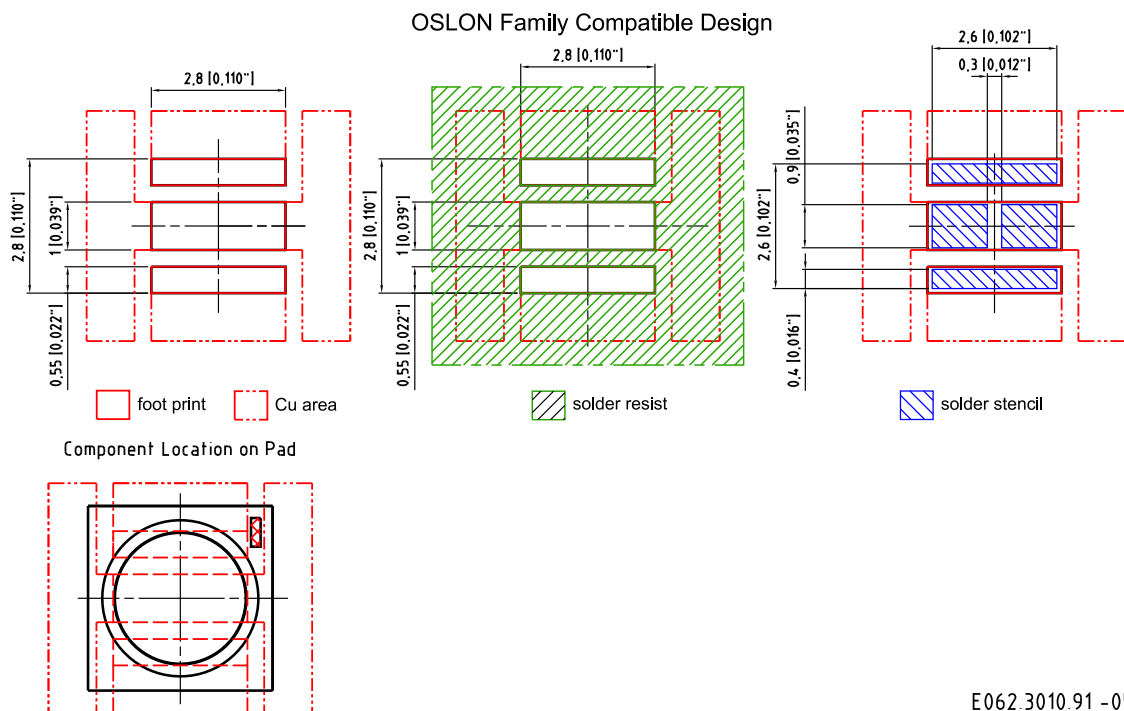
IRED is protected by ESD device which is connected in parallel to chip.

**Note:**

Package is not suitable for ultra sonic cleaning.

**Note:****Corrosion robustness better than EN 60068-2-60 (method 4):** with enhanced corrosion test: 40°C / 90%rh / 15ppm H<sub>2</sub>S / 336h**Note:**

Anode mark: Anode pad has chamfered edge, which points to cathode

**Recommended Solder Pad***Dimensions in mm [inch].***Note:**

For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere.

### Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



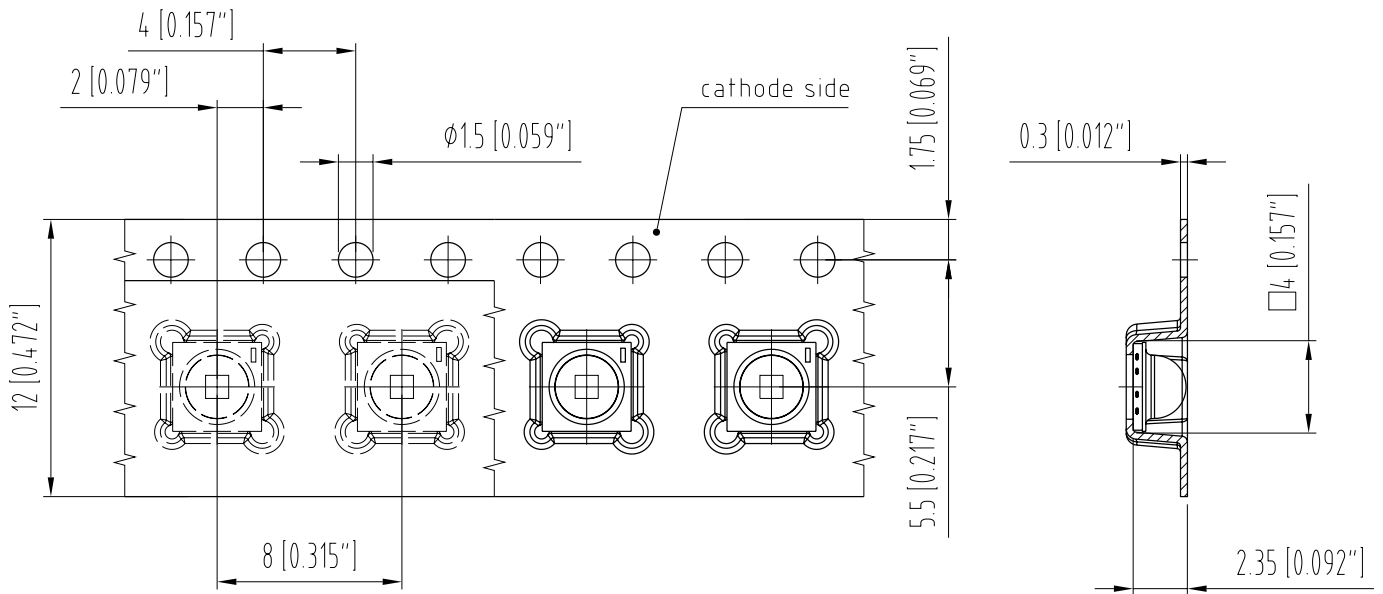
OHA04612

Profile Feature Profil-Charakteristik	Symbol Symbol	Pb-Free (SnAgCu) Assembly			Unit Einheit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*) 25 °C to 150 °C			2	3	K/s
Time $t_S$ $T_{Smin}$ to $T_{Smax}$	$t_S$	60	100	120	s
Ramp-up rate to peak*) $T_{Smax}$ to $T_P$			2	3	K/s
Liquidus temperature	$T_L$	217			°C
Time above liquidus temperature	$t_L$		80	100	s
Peak temperature	$T_P$		245	260	°C
Time within 5 °C of the specified peak temperature $T_P - 5\text{ K}$	$t_p$	10	20	30	s
Ramp-down rate* $T_P$ to 100 °C			3	6	K/s
Time 25 °C to $T_P$				480	s

All temperatures refer to the center of the package, measured on the top of the component

\* slope calculation  $DT/Dt$ :  $Dt$  max. 5 s; fulfillment for the whole T-range

**Taping**

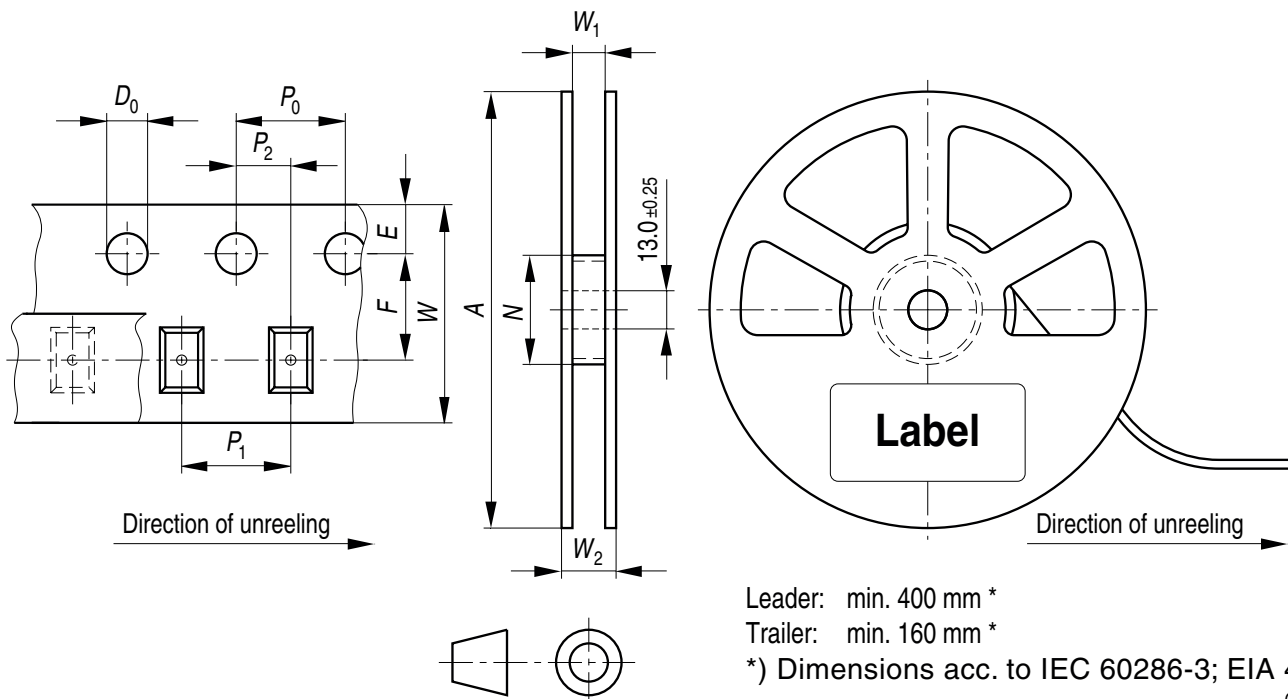


C63062-A4068-B10-08

*Dimensions in mm [inch].*

**Tape and Reel**

12 mm tape with 600 pcs. on  $\phi$  180 mm reel





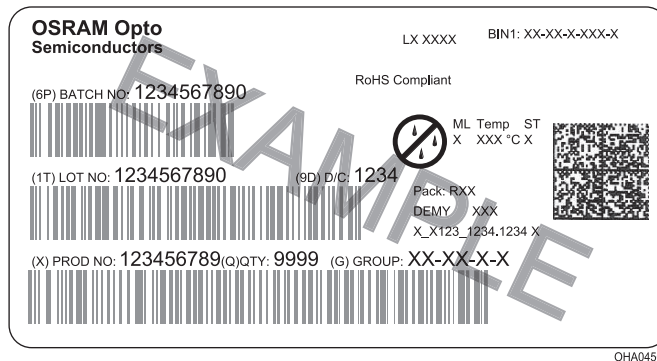
**Tape dimensions [mm]**

W	P <sub>0</sub>	P <sub>1</sub>	P <sub>2</sub>	D <sub>0</sub>	E	F
12 + 0.3 / - 0.1	4 ± 0.1	4 ± 0.1 or 8 ± 0.1	2 ± 0.05	1.5 ± 0.1	1.75 ± 0.1	5.5 ± 0.05

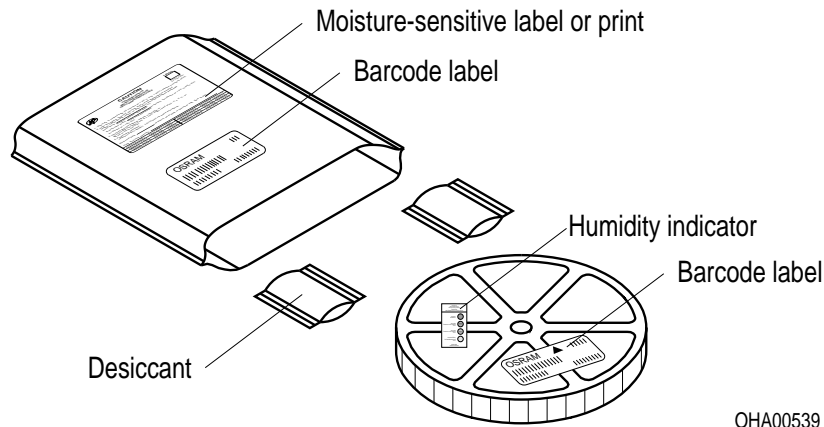
**Reel dimensions [mm]**

A	W	N <sub>min</sub>	W <sub>1</sub>	W <sub>2max</sub>
180	12	60	12.4 + 2	18.4

**Barcode-Product-Label (BPL)**



**Dry Packing Process and Materials**



**Note:**

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card. Regarding dry pack you will find further information in the internet. Here you will also find the normative references like JEDEC.

## Transportation Packing and Materials



## Dimensions of transportation box in mm

Width	Length	Height
195 ± 5	195 ± 5	30 ± 5

**Disclaimer**

Language english will prevail in case of any discrepancies or deviations between the two language wordings.

**Attention please!**

The information describes the type of component and shall not be considered as assured characteristics.

Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version in the Internet.

**Packing**

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office.

By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

**Components used in life-support devices or systems must be expressly authorized for such purpose!**

Critical components\* may only be used in life-support devices\*\* or systems with the express written approval of OSRAM OS.

\*) A critical component is a component used in a life-support device or system whose failure can reasonably be expected to cause the failure of that life-support device or system, or to affect its safety or the effectiveness of that device or system.

\*\*) Life support devices or systems are intended (a) to be implanted in the human body, or (b) to support and/or maintain and sustain human life. If they fail, it is reasonable to assume that the health and the life of the user may be endangered.

**Glossary**

- <sup>1)</sup> **Typical Values:** Due to the special conditions of the manufacturing processes of LED, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.

**Published by OSRAM Opto Semiconductors GmbH**  
**Leibnizstraße 4, D-93055 Regensburg**  
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